



## **COOLPad**® CP1030 **ULTRA SOFT**

Interface pads



**Description**COOLPad® is a line of high performance thermal interface pads, developed to address the industry's growing requirements for easy application, low levels of thermal resistance and high conformability, even at the most challeging and uneven surfaces. COOLPad® is specially suitable for applications with low clamping forces between the heat generating component and the heat disspation surface.



#### **Features**

- Low Thermal Resistance
- High Conformability
- Electrically Insulating
- RoHS, REACH and compliant"



#### **Applications**

- Electronic components like LEDs, CPUs, MOS
- Mobiles, Laptops, Tablets
- **Electrical Vehicle Batteries**
- Power devices and modules"



### Delivery FormatSheets of 200x400m

- Die-cut parts"



# COOLPad® CP1030 ULTRA SOFT



#### **Typical Properties**

Properties	Standard	Unit	CP1030
Color	-	-	Light Blue
Carrier Type	-	-	Silicon
Carrier Reinforcement			No
Thickness	ASTM D374	mm (inch)	0,25-5,0 (0,010-0,20)
Density	ASTM D792	g/cm³	2,30
Thermal Conductivity	ASTM D5470	W/m.k	3,00
Volume Resistance	ASTM D257	ohms.cm	3.1*1011
Thermal Resistance (50psi)	ASTM D5470	°C-in2/W	0,02
Hardness	ASTM D2240	Shore 00	30±5
Thermal Resistance	ASTM D5470	°C	-60 to 200
Dielectric Strength	ASTM D149	kV/mm	> 4,0
Shelf Life	-		5 years